



## AUROLECTROLESS™ SMT 525G Immersion Gold

For PWB Metallization Applications

### Regional Product Availability

- North America
- Asia
- Europe

### Description

AUROLECTROLESS™ SMT 525G Immersion Gold bath produces uniform fine-grained deposits of pure gold on metallic substrates including electroless nickel and electroless palladium. The AUROLECTROLESS™ SMT 525G Immersion Gold bath is easy to control and has high tolerance to contaminants. Applied as part of ENIG or ENEPIG processes, the deposits are suitable for a wide variety of soldering and wire bonding applications.

### Advantages

- Lower gold content substantially reduces operating costs
- Environmental friendly solution, free of strong chelates such as EDTA
- Flexible and easy gold thickness control
- Excellent solderability

### Bath Make-up for 1 Litre Bath

**CAUTION! Hazardous cyanide-containing chemical.**

Component	Metric
Deionized Water	300 ml
AUROLECTROLESS™ SMT 525G Make-up Solution	450 ml
Potassium Gold Cyanide	1g
Deionized Water	To final operating volume

### Make-up Procedure

**CAUTION! Hazardous cyanide-containing chemical.**

- 1) Add 300 ml/l deionized water to a clean tank.
- 2) Slowly add AUROLECTROLESS™ SMT 525G Make-up Solution with continuous stirring.
- 3) Dissolve gold salts in a small volume of warm deionized water and add to the tank.
- 4) Adjust to final volume with deionized water.
- 5) Mix thoroughly.
- 6) Check pH and specific gravity and adjust as necessary.

## Operation Parameters

**CAUTION! Hazardous cyanide-containing chemical.**

Parameter	Range	Recommended
Gold Concentration	0.5–0.9 g/l	0.7 g/l
pH	5.8–6.2	6.0
Specific Gravity	1.11–1.15	1.13
Temperature	80–88°C	83°C
Agitation	Vigorous solution and/or mechanical	
Deposition Thickness	0.05–0.12 microns (2.0–4.8 microinches) in 10–15 minutes (on electroless nickel substrates)	

## Bath Maintenance

**CAUTION! Hazardous cyanide-containing chemical.**

### Gold Salt

Gold metal content should be measured daily and replenished with additions of gold salts. Replenishment is based on the results from the AAS analysis described below.

### AUROLECTROLESS™ SMT 525G Replenisher

AUROLECTROLESS™ SMT 525G Replenisher is required to maintain the basic constituents of the electrolyte. Add 100 ml AUROLECTROLESS™ SMT 525G Replenisher for every 10g of gold metal deposited.

### Specific Gravity

Specific gravity should be measured daily and maintained in the recommended range by additions of AUROLECTROLESS™ SMT 525G Make-up Solution. Add 65 ml/l of AUROLECTROLESS™ SMT 525G Make-up Solution to raise the specific gravity by 0.01 units.

### pH

pH should be measured daily (on a sample cooled to room temperature) and maintained in the recommended range by additions of AUROLECTROLESS™ SMT 500 Acid Solution or potassium hydroxide. Add 10 ml/l (1% v/v) AUROLECTROLESS™ SMT 500 Acid Solution to lower the pH by 0.1 unit. Add 0.75–1.0 g/l potassium hydroxide to raise the pH by 0.1 units. Dissolve the potassium hydroxide in water before making an addition.

## Bath Analysis

### Gold Content—by Atomic Absorption Spectroscopy

#### I. Equipment

- a) 1 ml pipette
- b) 100 ml volumetric flask

#### II. Reagents

Gold standard solutions (6 ppm and 12 ppm)

#### III. Procedures

- a) Pipette 1 ml of sample solution into a 100 ml volumetric flask.
- b) Dilute to the mark with deionized water.
- c) Calibrate AAS with 6 ppm and 12 ppm Gold standards.
- d) Measure gold content of the diluted sample solution for gold metal.
- e) Record AAS reading

#### IV. Calculation

Gold concentration (g/L) = AAS Reading × 0.1

#### V. Replenishment

Required addition of gold salt (g) =

$[(0.7 - \text{measured gold concentration(g)}) \times \text{tank volume (liters)}] / 0.683$

### Equipment

Tanks: Suitable heat resistant, stress-relieved natural polypropylene  
Heaters: Immersion heaters (glass, porcelain or PTFE)  
Filtration: Continuous solution filtration using 5 micron woven polypropylene cartridges

### Operation Notes

- 1) The AUROLECTROLESS™ SMT 525G Immersion Gold bath should be replaced after approximately 14 metal turnovers, when the nickel in the bath reaches 900 ppm, or when the copper reaches 10 ppm (whichever comes first).
- 2) If necessary, the deposition rate can be increased by one or more additions of AUROLECTROLESS™ SMT 500 Additive. Individual adds of 2 ml/l AUROLECTROLESS™ SMT 500 Additive should be made. Do not add more than a total of 8 ml/l of AUROLECTROLESS™ SMT 500 Additive during each bath adjustment.

### Product Data

#### AUROLECTROLESS™ SMT 525G Make-up

Appearance: Pale yellow to yellow solution

pH: 6.0–6.4

Specific Gravity: 1.243–1.287

#### AUROLECTROLESS™ SMT 525G Replenisher

Appearance: Clear, colorless to very pale yellow solution

pH: 5.8–6.2

Specific Gravity: 1.108–1.147

#### AUROLECTROLESS™ SMT 500 Acid Solution

Appearance: Clear, colorless solution

Total Acidity: 2.8–3.3 mol/L

Specific Gravity: 1.062–1.098

#### AUROLECTROLESS™ SMT 500 Additive

Appearance: Colorless solution

Specific Gravity: 1.006–1.038

**Handling  
Precautions**

Before using this product, consult the Material Safety Data Sheet (MSDS)/Safety Data Sheet (SDS) for details on product hazards, recommended handling precautions and product storage.

**WARNING!** DO NOT ACIDIFY this product or working bath containing this product below specified operating pH range, or below pH 7 if no range is specified. Acidification may release highly toxic cyanide gas, which can be fatal if swallowed, inhaled or absorbed through the skin.

**CAUTION!** Keep combustible and/or flammable products and their vapors away from heat, sparks, flames and other sources of ignition including static discharge. Processing or operating at temperatures near or above product flashpoint may pose a fire hazard. Use appropriate grounding and bonding techniques to manage static discharge hazards.

**CAUTION!** Failure to maintain proper volume level when using immersion heaters can expose tank and solution to excessive heat resulting in a possible combustion hazard, particularly when plastic tanks are used.

**Storage**

Store products in tightly closed original containers at temperatures recommended on the product label.

**Disposal  
Considerations**

Dispose in accordance with all local, state (provincial) and federal regulations. Empty containers may contain hazardous residues. This material and its container must be disposed in a safe and legal manner.

It is the user's responsibility to verify that treatment and disposal procedures comply with local, state (provincial) and federal regulations. Contact your Dow Electronic Materials Technical Representative for more information.

**Product  
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